



# Military Sensor Fusion Next-Gen Embedded AI Systems

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Real-Time C4ISR and Tactical Decision

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# 1\_INTRODUCTION

## Purpose

This white paper provides an in-depth analysis of the IV320 and AV710, NV200 and NV300 HPC systems, highlighting their advanced technical capabilities and performance across various demanding applications.

In response to the evolving landscape of AI-driven asymmetric warfare, military integrators are continuously seeking robust computational systems that offer superior multifaceted-computing capabilities and can endure harsh environmental conditions, such as shock, vibration, and extreme temperature variations. 7StarLake's IV320, AV710, NV200, and NV300 HPC systems combine Intel® and NVIDIA® AI accelerators within rugged MIL-STD-810/461-certified enclosures, purpose-built for C4ISR, autonomous control, and real-time battlefield data fusion. These systems provide unmatched computational density and reliability across land, air, and naval missions.



These systems cater to diverse applications requiring high computing power and ruggedness, ranging from ground surveillance and reconnaissance to mobile navigation and vehicle monitoring. The IV320, AV710, NV200 and NV300 are engineered to consolidate ISR (Intelligence, Surveillance, and Reconnaissance) platforms, heralding a new era of

edge AI computing.

This paper delves into the technological advancements and capabilities of the IV320, AV710, NV200 and NV300, demonstrating how they enhance situational awareness, optimize decision-making, and provide a strategic advantage on the battlefield.



## 2\_OVERVIEW OF MILITARY RUGGED EDGE SYSTEMS

# IV320

The IV320 is a high-performance, rugged HPC system designed for applications requiring robust computational power and real-time data processing in harsh environments.



## Key Features

### Intel® 13th Gen. Raptor Lake-H Processor

Core i7-13800HE/HRE, featuring 14 cores and 20 threads with clock speeds up to 5.0 GHz, ensuring exceptional computational throughput.

### Full IP65 Sealed Enclosure

Provides protection against dust, water, and extreme weather conditions, ensuring reliable operation in harsh environments.

### 8xChannel 3G-SDI Frame Grabber

Enables low-latency video capture and processing, creating a 360-degree protection screen for comprehensive situational awareness.

### NVIDIA® Quadro MXM RTX A4500

Equipped with 16GB GDDR6 and 5888 CUDA cores, This GPU Computer excels in AI inference, 3D rendering, and processing high-resolution visual data.

### MIL-STD-810 Compliance

Ensures resistance to shock and vibration, suitable for deployment in military and industrial settings.

## 2\_OVERVIEW OF MILITARY RUGGED EDGE SYSTEMS

# AV710

The AV710 is an ultra-small-form-factor (USFF) MIL-SPEC rugged edge AI computing solution, designed for next-generation edge applications requiring real-time AI processing.



JETSON  
AGX Orin

## Key Features

### NVIDIA® Jetson AGX Orin

Offers up to 275 TOPS of AI performance, making it ideal for AI and machine learning workloads, including autonomous systems, robotics, and smart city applications.

### Compact Design

Dimensions of 250 x 220 x 100mm, making it suitable for space-constrained installations.

### 4CH 3G-SDI Frame Grabber

Supports capturing high-definition 1920x1080p video at 60/50fps from up to four 3G-SDI inputs, providing high-quality video streams for tactical decision-making.

### MIL-STD-810 Compliance

Robust performance under thermal, shock, vibration, and humidity conditions, with IP65 classification for environmental protection.

### Extended Temperature Range

Operates reliably in temperatures ranging from -20 to +55°C, ensuring functionality in extreme conditions.





# NV200, NV300

The NV200 and NV300 are ultra-small-form-factor (USFF) MIL-SPEC rugged edge compute solutions. Built with a Modular Open Systems Approach (MOSA) and a modular chassis architecture, these systems integrate the NVIDIA Jetson AGX Orin/Orin NX as next-gen and power-efficient edge AI computing solutions.



JETSON  
AGX Orin



## Key Features

### NVIDIA® Jetson AGX Orin

Up to 275 TOPS of AI performance, configurable power consumption 15W – 60W, designed for the demanding AI projects, like autonomous systems, robotics, and smart city applications.

### Ultra Compact Design

Ultra-compact for edge AI deployment, SWaP-optimized for integration in highly space-constrained platforms

### NVIDIA® Jetson Orin NX

Offering up to 100 TOPS of AI performance, configurable between 10W and 25W, Jetson Orin NX is a balanced option for power consumption and computing performance, targeting the market of drones, robotics and other embedded AI system.

### Support GMSL2 Camera Input

The systems supports, to carry high-speed video, bidirectional control data, and power over a single coaxial cable.

### Extended Temperature Range

Operates reliably in temperatures ranging from -20 to +55°C, ensuring functionality in extreme conditions.

## 3\_TECHNICAL SPECIFICATIONS

### CPU

#### IV320 CPU

The Intel® 13th Gen. Raptor Lake-H, Core i7-13800HE/HRE features 14 cores and 20 threads, with clock speeds reaching up to 5.0 GHz. This processor is supported by up to 96 GB of DDR5 memory, delivering exceptional computational performance for AI targeting, scientific computations, and object detection tasks.



#### AV710 CPU

Utilizes the NVIDIA® Jetson AGX Orin, which integrates a 12-core Arm® Cortex®-A78AE v8.2 64-bit CPU with 3MB L2 and 6MB L3 cache, the system is tailored for real-time AI inference, sensor fusion, and high-performance computing applications.



JETSON  
AGX Orin



#### IV320 GPU

The NVIDIA Quadro RTX A4500, with 16GB GDDR6 VRAM and 5888 CUDA cores, excels in transforming high-resolution visual data into actionable insights, supporting applications such as EO/IR, thermal cameras and 3D radar.



#### AV710 GPU

The NVIDIA Jetson AGX Orin module provides robust AI processing capabilities with up to 275 TOPS. This high-performance module is optimized for complex AI tasks, including image recognition and object detection, making it ideal for edge AI applications.



JETSON  
AGX Orin



### GPU





# Video Input/ Output

3G-SDI is a broadcast-grade digital video interface standard that supports video resolutions up to 1080p at 60 frames per second. It enables high-speed, uncompressed digital video transmission over coaxial cables, providing superior image quality and minimal latency. This technology is crucial in professional video environments where maintaining signal integrity and high resolution is paramount.



### IV320

Equipped with an 8-channel 3G-SDI configuration, the IV320 is designed for demanding video applications that require simultaneous input from multiple video sources. This capability ensures comprehensive coverage and monitoring, essential for complex operations.



### AV710

Featuring advanced video processing capabilities, the AV710 supports up to 4 channels 3G-SDI, making it ideal for environments where space and power efficiency are critical without compromising on video quality.



### NV200 and NV300

Both models are equipped with 4-channel 3G-SDI configurations, providing robust and reliable video transmission for various applications. These systems are optimized for scenarios requiring multiple video feeds with high fidelity and low latency.



# Frame Grabber Card

This component is vital for real-time data analysis and integration with central command systems for comprehensive ISR operations

### Mini-PCIe Frame Grabber Card

«for HD-SDI & PAL in/out put»



### M.2 M-Key 2280 Frame Grabber Card

«for 3G-SDI & PAL in/out put»



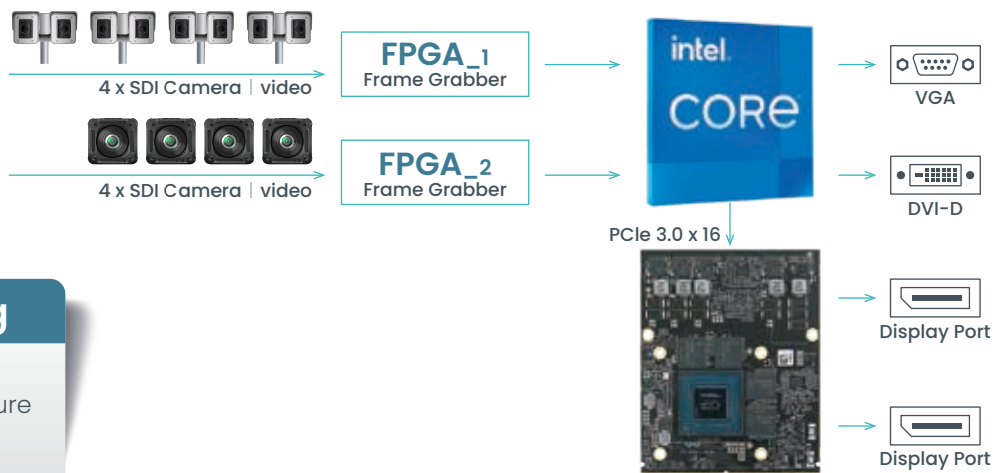
## 4\_HIGH-PERFORMANCE GPU COMPUTING

GPU computing is essential for high-performance computing (HPC) applications, enabling accelerated data processing and complex computational tasks.



### IV320 GPU Computing

The NVIDIA Quadro RTX A4500 supports advanced GPU computing capabilities with libraries such as CUDA and OpenCL. This GPU excels in AI inferencing, scientific simulations, and rendering tasks, providing substantial performance improvements in HPC workloads.



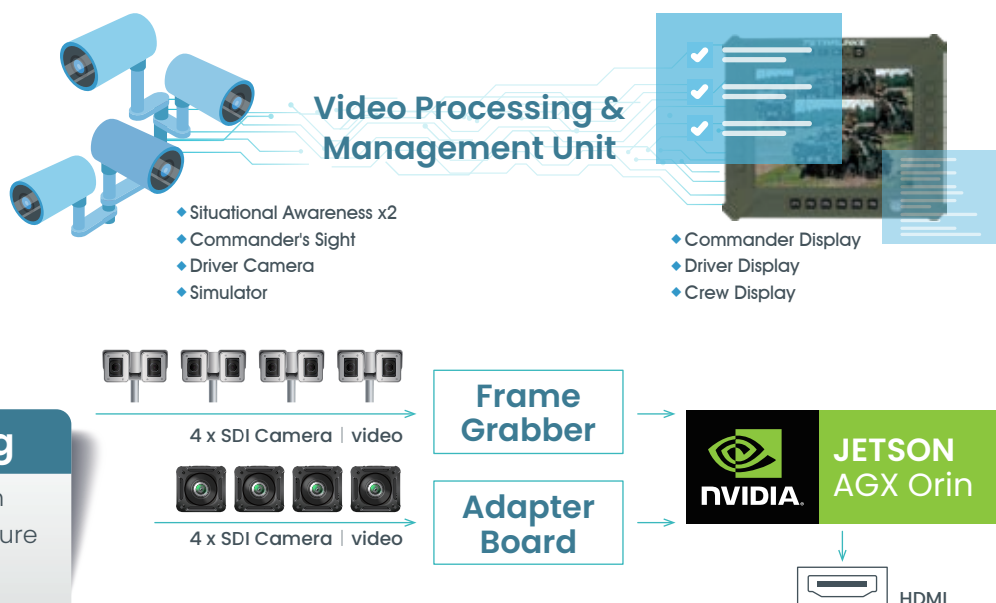
#### AI Processing

- ▶ AI Object Detection
- ▶ HD-SDI Video Capture
- ▶ Video Encoding



### AV710 GPU Computing

The NVIDIA Jetson AGX Orin module is optimized for AI and machine learning workloads, featuring powerful CUDA cores for neural network computations. This enables efficient execution of tasks like image recognition and object detection, making it ideal for edge AI applications in constrained environments.



#### AI Processing

- ▶ AI Object Detection
- ▶ HD-SDI Video Capture
- ▶ Video Encoding



## 4\_HIGH-PERFORMANCE GPU COMPUTING



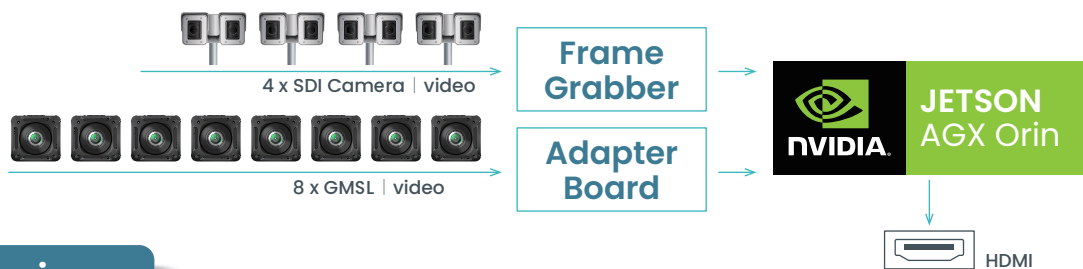
### NV300 GPU Computing

The NVIDIA Jetson AGX Orin module offers top-tier performance for AI applications, featuring an Ampere GPU with 2048 CUDA and 64 Tensor cores, a 12-core ARM CPU, 32GB LPDDR5, and 64GB eMMC storage. It supports real-time AI inference, sensor fusion, and high-performance computing for demanding workloads.



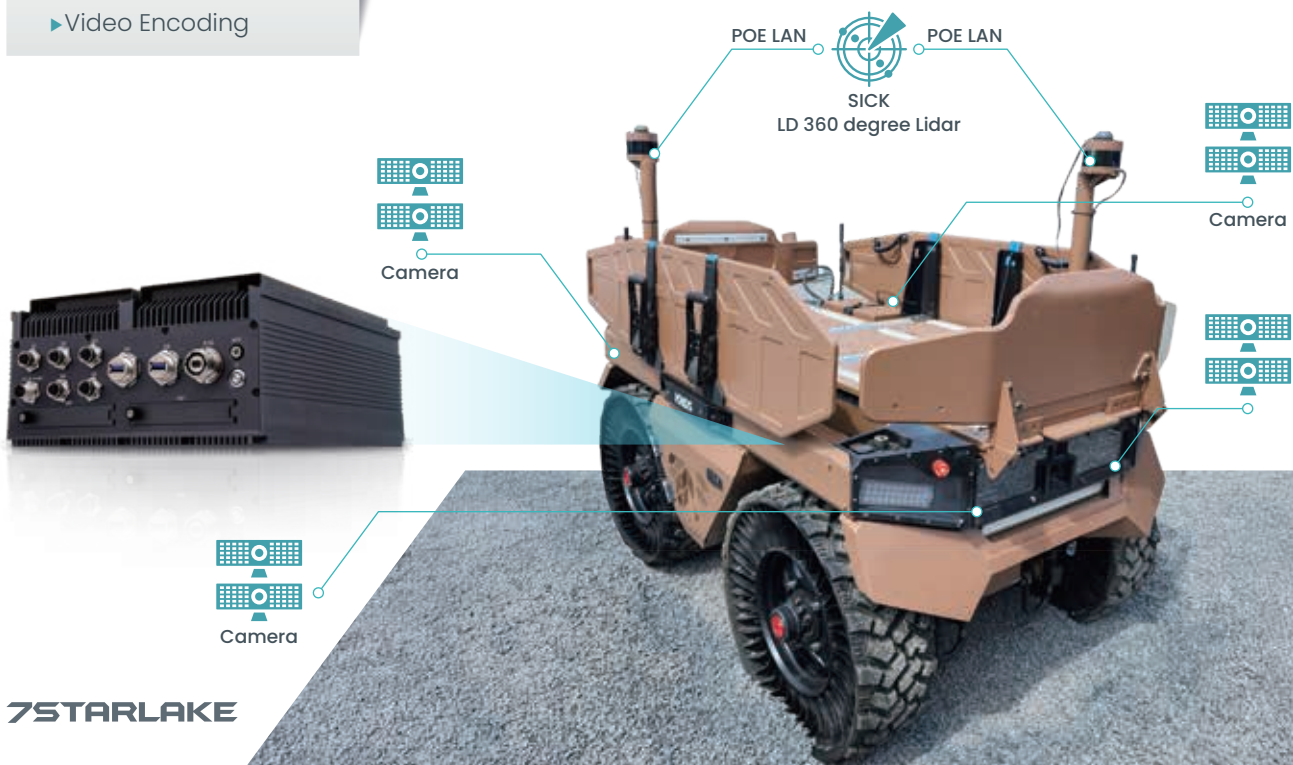
### NV200 GPU Computing

The NVIDIA Jetson Orin NX module is optimized for AI and machine learning workloads, featuring powerful CUDA cores for neural network computations. This enables efficient execution of tasks like image recognition and object detection, making it ideal for edge AI applications in constrained environments. It powers applications such as autonomous robots, smart cameras, drones, and IoT devices, providing advanced AI capabilities while maintaining energy efficiency and compact form factor.



### AI Processing

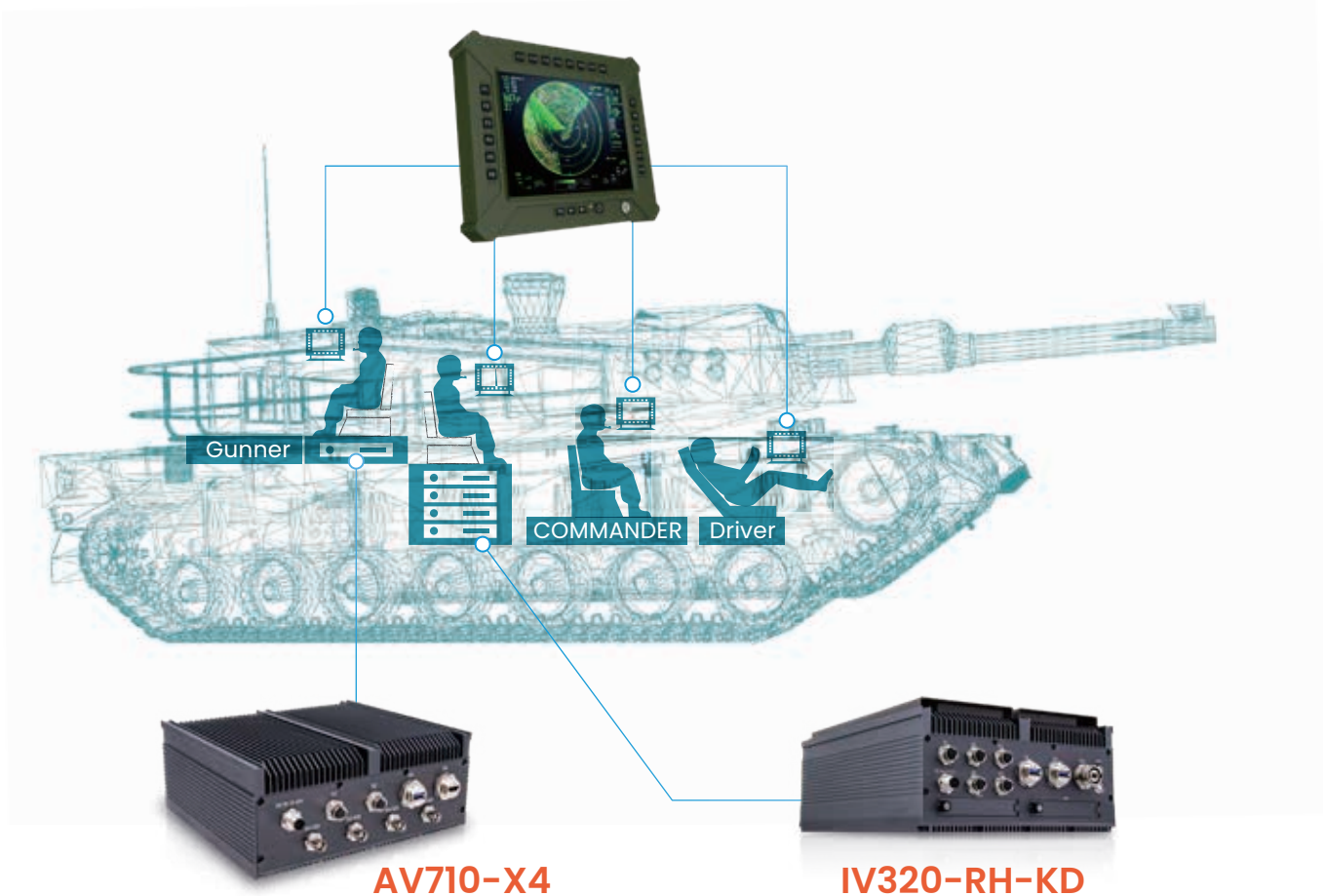
- ▶ AI Object Detection
- ▶ HD-SDI Video Capture
- ▶ Video Encoding



## 5\_APPLICATIONS AND USE CASES

### Armored Vehicle Security

Implementing a 360-degree panoramic defensive bubble with the IV320's 8x 3G-SDI channels and GPGPU integration, these systems provide early detection and tracking of air and surface targets, enhancing vehicle protection and decision-making capabilities in combat scenarios.





## 6\_CONCLUSION

### Summary

The IV320 , AV710, NV200 and NV300 HPC systems, powered by Intel and NVIDIA technologies, integrate advanced 3G-SDI and frame grabber capabilities to deliver high-performance computing solutions for defense and industrial applications. These systems enhance ISR capabilities, enable quick decision-making, and provide robust computational power in harsh environments.

## 7\_PRODUCT LISTS\_IV320



### IV320 Series



#### IV320-RH-KD

- ▶ Intel® 13th Gen. Raptor Lake-H, Core i7-13800HRE/HE
- ▶ NVIDIA® Quadro RTX A4500 (16GB GDDR6, 5,888 CUDA)
- ▶ 8 x Channel 3G-SDI Input Frame Grabber



#### IV320-RH

- ▶ Intel® 13th Gen. Raptor Lake-H, Core i7-13800HE/HRE
- ▶ NVIDIA® Quadro MXM RTX A4500 (16GB GDDR6, 5888 CUDA)



#### IV320-RS

- ▶ Intel® 14/13/12 Gen. Raptor Lake-R/S, Alder Lake-S, Core i9/i7
- ▶ NVIDIA® Quadro RTX A4500 (16GB GDDR6, 5,888 CUDA)
- ▶ 4 x POE ( 2 x POE for 30W ; 2 x POE for 60W)

## 7\_PRODUCT LISTS\_AV710

Future developments and enhancements for the AV710 will focus on increasing computational performance, expanding AI capabilities, and further ruggedizing these systems to meet evolving defense and industrial needs.

### AV710 Series



#### AV710

- ▶ Intel® Core™ i7-6822EQ
- ▶ NVIDIA® I050Ti CUDA 768  
GDDR5-4GB/Quadro® RTX3000  
CUDA 1920 GDDR6-6GB



#### AV710-X2

- ▶ AGX Xavier 32GB with 8-core NVIDIA Carmel Arm®, 32 TOPs
- ▶ 512-core NVIDIA Volta architecture GPU with 64 Tensor Cores
- ▶ 1CH HD-SDI



#### AV710-X3

- ▶ Intel® Xeon® D-1577, 45W, Broadwell, Freq. 1.3/2.1GHz, 16C, 24M Cache
- ▶ NVIDIA® Quadro® RTX5000 CUDA 3072



#### AV710-X4

- ▶ AGX Orin 32GB with 8-core Arm® Cortex®, 200 TOPs
- ▶ 1792-core NVIDIA Ampere with 56 Tensor Cores
- ▶ 4CH 3G-SDI



#### AV710-VM-E

- ▶ Intel® Xeon® W-11865MRE, 8 Cores, 24M Cache, 2.6GHz (4.7GHz), 45W (RM590E)
- ▶ NVidia® RTX A2000, 4G/8G 2560 CUDA Cores, PCIe Gen3.0 x164
- ▶ 4 x 3G-SDI video channels and 8 x composite (PAL) channels.



### The NV200 and NV300 series

represent a robust and versatile range of video transmission solutions designed to meet the demanding requirements of various applications. These series are engineered to deliver high-performance, reliability, and advanced features for seamless integration into any professional video setup.

## NV300 Series



### NV300-2L32

- ▶ AGX Orin 32GB with 8-core Arm® Cortex®, 200 TOPs
- ▶ 1792-core NVIDIA Ampere with 56 Tensor Cores



### NV300-2LS64

- ▶ AGX Orin 64GB with 12-core Arm® Cortex®, 275 TOPs
- ▶ 2048-core NVIDIA Ampere with 64 Tensor Cores
- ▶ 4CH 3G-SDI



### NV300-2LGS64

- ▶ AGX Orin 64GB with 12-core Arm® Cortex®, 275 TOPs
- ▶ 2048-core NVIDIA Ampere with 64 Tensor Cores
- ▶ 4CH 3G-SDI    ▶ 4CH GMSL

## NV200 Series



### NV200-2L16

- ▶ Orin NX 16GB with 8-core Arm® Cortex®, 100 TOPs
- ▶ 1024 NVIDIA® CUDA® cores with 32 Tensor cores



### NV200-2LS16

- ▶ Orin NX 16GB with 8-core Arm® Cortex®, 100 TOPs
- ▶ 1024 NVIDIA® CUDA® cores with 32 Tensor cores



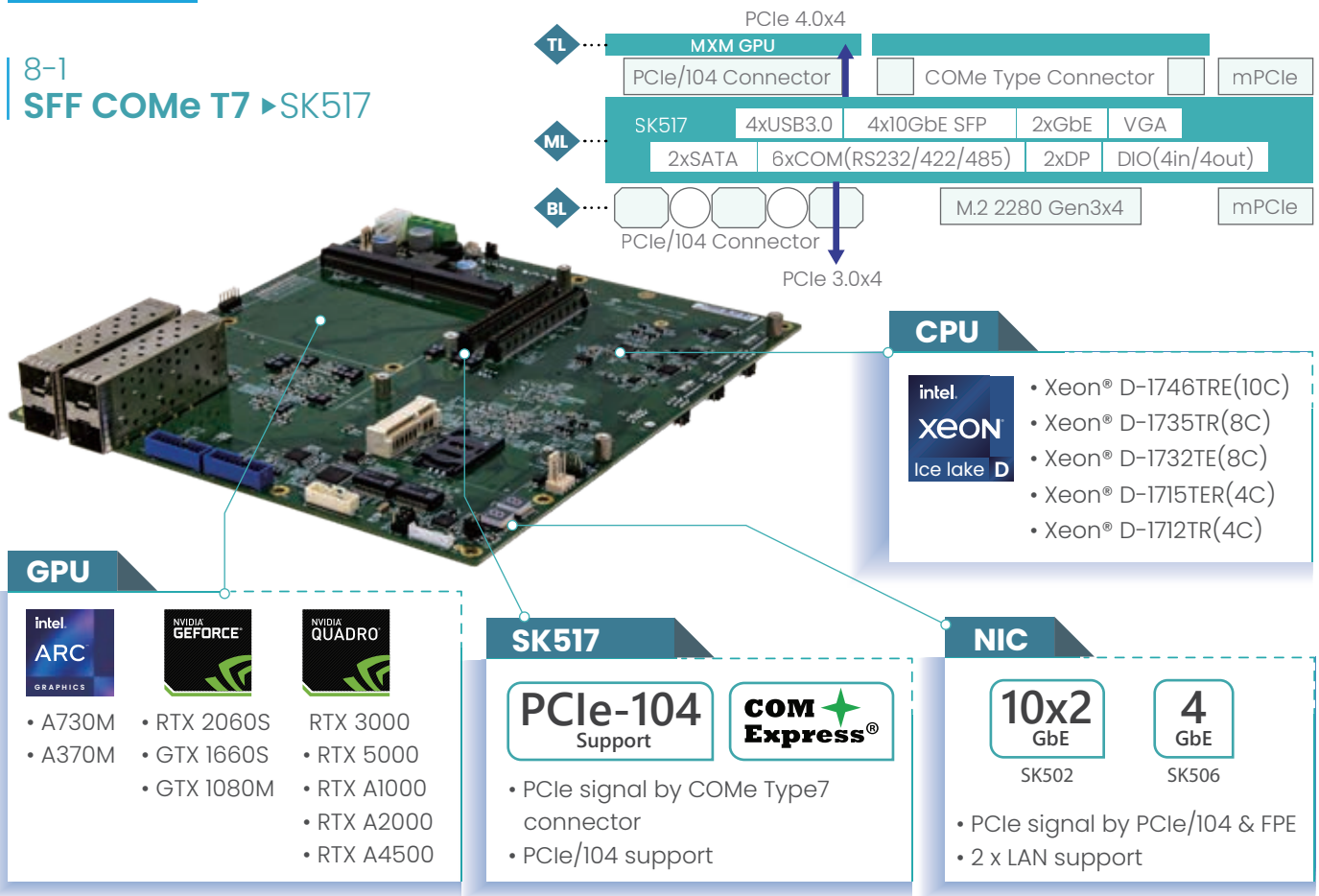
### NV200-2LGS16

- ▶ Orin NX 16GB with 8-core Arm® Cortex®, 100 TOPs
- ▶ 1024 NVIDIA® CUDA® cores with 32 Tensor cores
- ▶ 4CH 3G-SDI    ▶ 4CH GMSL

## 8\_COMe T6/T7

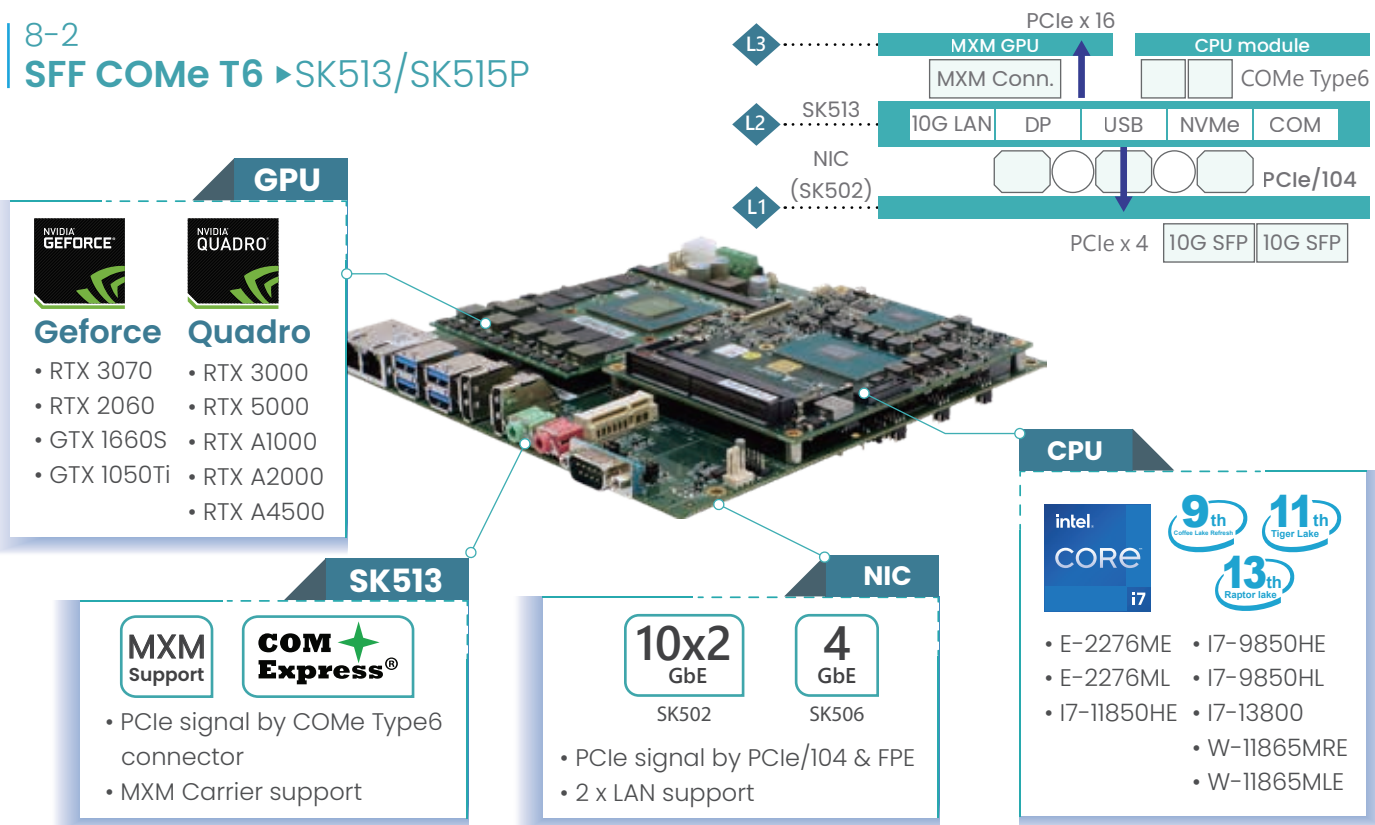
8-1

### SFF COMe T7 ▶ SK517



8-2

### SFF COMe T6 ▶ SK513/SK515P





# 9\_HIGHLIGHTS\_MIL-STD-810

## High Temperature

- MIL-STD-810G Test Method 501.5 high Temp  
(96 hours@75°C non-operating + 72 hours @ 75°C operating)



This testing method is broken down into two procedures.

- Procedure I (storage) exposes the system to high temperatures while it is turned off, and its purpose is to test the durability of the materials that make up the system. The chamber temperature is 75°C and the test duration is 96 hours.
- Procedure II (operation) is to test how the device puts up with heat while having it turned on and used.
- The chamber temperatures used in an operational cyclical test is 75°C, and the test duration is 72 hours. The temperature needs to cycle from one end to the other a minimum of three times while testing that the device functions at every point in the test.

## Low Temperature

- MIL-STD-810G Test Method 502.5 Low Temp  
(96 hours@-40°C non-operating +72 hours@-40°C operating)



There are two parts in this test to determine whether the system can persevere in extremely cold environment.

- Procedure I (storage) exposes the system to low temperatures while it is turned off, and its purpose is to test the durability of the materials that make up the system. The chamber temperature is -40°C and the test duration is 96 hours.
- Procedure II (operation) testing involves slowly cooling the device to the low temperature and leaving it at that temperature for at least two hours, checking to see that it is still functioning during that time. The chamber temperature is -40°C and the test duration is 72 hours.

# 9\_HIGHLIGHTS\_MIL-STD-461/ 1275 Certified

Electronic Warfare (EW) has become more and more common in battlefield, and maintaining Electromagnetic Spectrum Superiority is one of the key goals.

AV600/SR700 Series is certified with MIL-STD-461/1275, which ensure to withstand Voltage Spikes, control electromagnetic interference (EMI) emissions and maintain electromagnetic compatibility (EMC).

ELECTROMAGNETIC  
**MIL-STD-461**

Ensures function properly within electromagnetic (EM) environments and avoid releasing EM energy cause EM interference (EMI) with nearby devices.

**CE 102** ►►10 kHz-30 MHz  
Conducted Emissions, Radio Frequency Potentials & Power Leads, basic curve

**RE 102** ►►30 MHz-5 GHz  
Radiated Emissions, Electric Field

**RE 103** ►►80 MHz-3 GHz  
Radiated susceptibility, Electric Field

when powered from a 28V supply, ensuring that electronics survive in the field when faced with input voltage spikes and surges.

Surge High | 100V / 500ms

Surge Low | 18V / 500ms

Steady State | 18V~33V

VEHICLE  
**MIL-STD-1275**

## 9\_HIGHLIGHTS\_MIL-STD 461

	MIL-STD 461 (Ground Vehicle)	MIL-STD 461/1275 (Aircraft)	MIL-STD 461/1275/704 (Aircraft)
CEI02	CEI02 basic curve, 10kHz - 30 MHz		
REI02-4	N/A	REI02-4, (10 KHz)-2.0 MHz	
	REI02-4, (1.5 MHz ) -30.0 MHz	REI02-4, (1.5 MHz)-30.0 MHz	
	REI02-4, ( 30.0 MHz) - 5.0 GHz	REI02-4, (30.0 MHz)-5.0 GHz	
	N/A	REI02-4, (5 GHz)-18 GHz	
RSI03	RSI03, ( 200 MHz ) - 3 GHz,		
	RSI03, (1.5 MHz) - 200 MHz, 50 V/m equal for all frequencies		
	RS 103,(3.0 GHZ) - 5.0 GHz 50V/m equal for all frequencies		
EN61000	EN 61000-4-2: Air discharge: 8 kV,Contact discharge: 6kV		
	EN 61000-4-3: 10V/m		
	EN 61000-4-4: Signal and DC-Net: 1 kV		
	EN 61000-4-5: Leads vs. ground potential 1kV, Signal und DC-Net: 0.5		
EN55022	EN 55022, Class A		
CS	CS101 (30HZ-150KHZ)		
	CS114 (10kHz-200MHz)		
	CS11550v/m		
	CS116 50v/m		
MIL-STD-1275	N/A	Steady State - 20V~33V,	
		Surge Low - 18V/500ms,	
		Surge High - 100V/500ms	
		Emitted Spikes	
		Injected Voltage Surges	
		Emitted Voltage Surges	
		Voltage Ripple (2V)	
		Voltage Spikes	
		Starting Operation	
Reverse Polarity			
MIL-STD-704	N/A	N/A	Load Measurements (LDC101)
			Steady State Limits for Voltage(LDC102)
			Voltage Distortion Spectrum (LDC103)
			Total Ripple (LDC104)
			Normal Voltage Transients (LDC105)
			Power Interrupt (LDC201)
			Abnormal Steady State Limits forVoltage (LDC301)
			Abnormal Voltage Transients (LDC302)
			Emergency Steady State Limits for Voltage (LDC401)
			Starting Voltage Transients (LDC501)
			Power Failure (LDC601)
Phase Reversal (LDC602)			



## 10\_PRODUCT SPECIFICATIONS

### IV320 Series



	IV320-RH-KD	IV320-RS	IV320-RH
Architecture	COM Express	Single Board	COM Express
Cooling	Conduction Cooling With External Turbo Fan	Conduction Cooling With External Turbo Fan	Conduction Cooling With External Turbo Fan
CPU	i7-13800HRE	i9-14900T	i7-13800HRE
GPU	MXM A4500	MXM A4500	MXM A4500
RAM	Up to 64GB	Up to 128GB	Up to 64GB
Capture Card	2 x 3G-SDI	N/A	N/A
Storage(Internal)	1 x M.2 NVMe	1 x M.2 NVMe	1 x M.2 SATA
AES (H/W) Key	N/A	N/A	N/A
Swappable CMOS	N/A	N/A	N/A
POWER	12V~36V DC-IN	12V DC-IN	12V DC-IN
Graphic Output	MiniDP	VGA	VGA
Dimensions	250 x 325 x 138 mm	250 x 325 x 100 mm	250 x 325 x 100 mm
MIL-STD-461	N/A	N/A	N/A
MIL-STD-810	compliance	compliance	compliance
CE	compliance	compliance	compliance

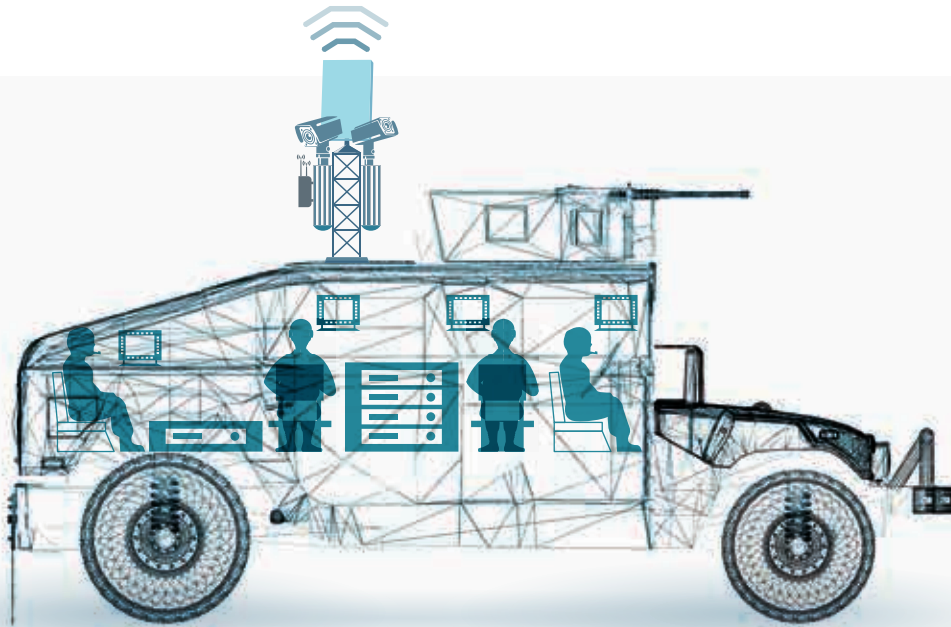
## 10\_PRODUCT SPECIFICATIONS

# AV710 Series



	AV710	AV710-X2
Architecture	EBX	Jetson
Cooling	Conduction Cooling	Conduction Cooling
CPU	i7-6822EQ	ARM® v8.2 64-Bit
GPU	MXM GTX1050Ti	AGX Xavier
RAM	Up to 32GB	Up to 32GB
Capture Card	N/A	Option
Storage(Internal)	1 x mSATA	1 x M.2 NVMe
AES (H/W) Key	N/A	N/A
Swappable CMOS	N/A	N/A
POWER	9V~36V DC-IN	18V~36V DC-IN
Graphic Output	DVI	DVI
Dimension	280 x 320 x 122 mm	230 x 280 x 83 mm
MIL-STD-461	compliance	compliance
MIL-STD-810	compliance	compliance
CE	compliance	compliance

## 10\_PRODUCT SPECIFICATIONS



AV710-X3	AV710-X4	AV710-VM-E
COM Express	Jetson	COM Express
Conduction Cooling With External Turbo Fan	Conduction Cooling	Conduction Cooling
D-1577	Cortex®-A78AE	W-11865MRE
MXM RTX5000	AGX Orin	MXM A2000
Up to 32GB	Up to 64GB	Up to 96GB
N/A	1 x 3G-SDI	4 x 3G-SDI
1 x M.2 NVMe	1 x M.2 NVMe	1 x M.2 SATA
N/A	N/A	N/A
N/A	N/A	N/A
9V~36V DC-IN	12V~36V DC-IN	9V~36V DC-IN
DVI	HDMI	MiniDP
280 x 230 x 122 mm	250 x 220 x 100 mm	250 x 350 x 100 mm
compliance	N/A	N/A
compliance	compliance	compliance
compliance	compliance	compliance

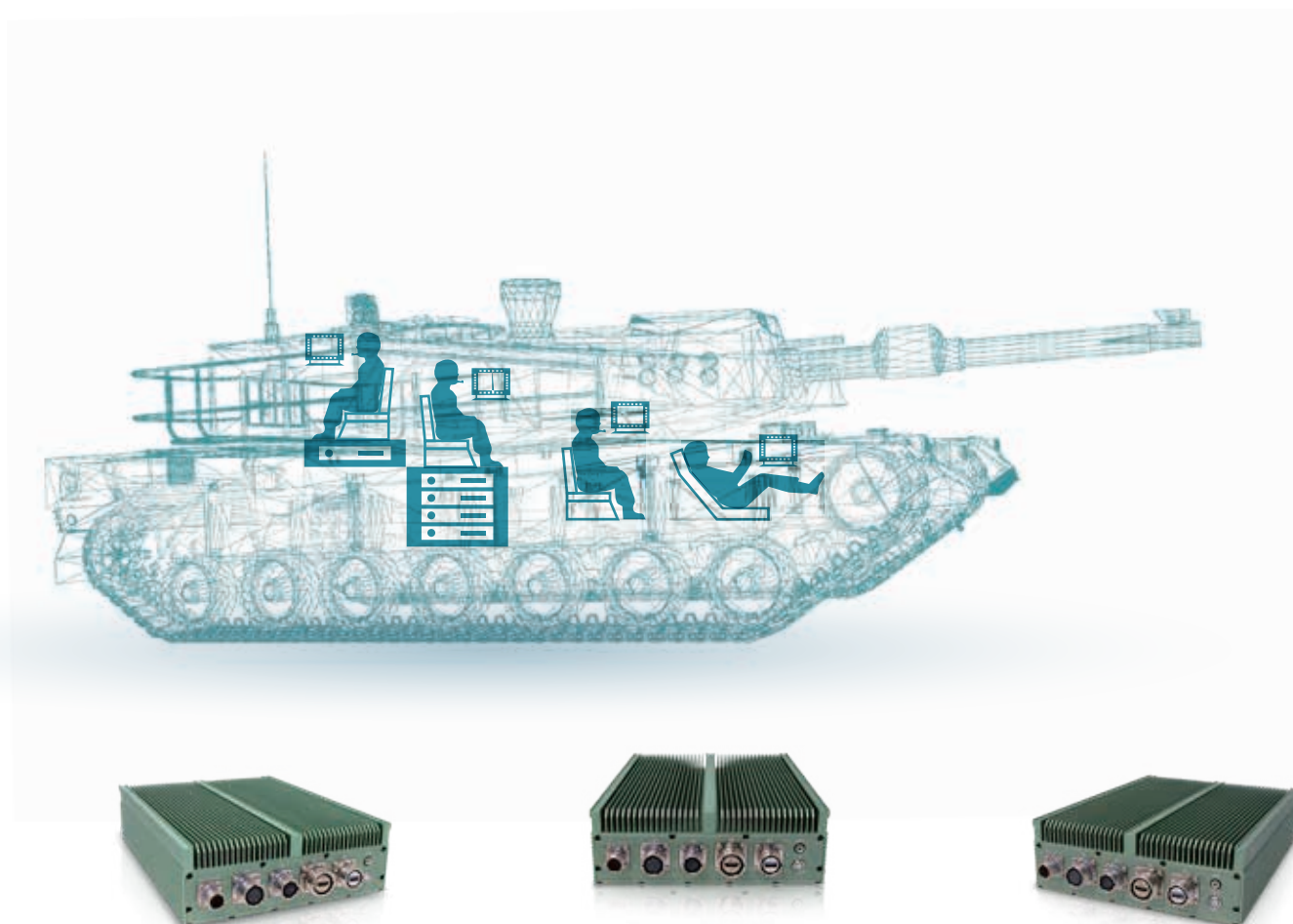


## NV200 & NV300 Series



	NV200-2L16	NV200-2LS16	NV200-2LGS16
Architecture	Jetson	Jetson	Jetson
Cooling	Conduction Cooling	Conduction Cooling	Conduction Cooling
CPU	Arm Cortex-A78AE CPU	Arm Cortex-A78AE CPU	Arm Cortex-A78AE CPU
GPU	Orin NX	Orin NX	Orin NX
RAM	16GB	16GB	16GB
Capture Card	No	4x 3G-SDI	4x 3G-SDI + 4x GMSL
Storage(Internal)	2x M.2 NVMe	1x M.2 NVMe	1x M.2 NVMe
AES (H/W) Key	NA	NA	NA
Swappable CMOS	NA	NA	NA
POWER	18V~36V	18V~36V	18V~36V
Graphic Output	HDMI	HDMI	HDMI
Dimension	220 x 300 x 88mm	220 x 300 x 88mm	220 x 300 x 88mm
MIL-STD-461	compliance	compliance	compliance
MIL-STD-810	compliance	compliance	compliance
CE	compliance	compliance	compliance

## 10\_PRODUCT SPECIFICATIONS



NV300-2L32	NV300-2LS64	NV300-2LGS64
Jetson	Jetson	Jetson
Conduction Cooling	Conduction Cooling	Conduction Cooling
Arm Cortex-A78AE CPU	Arm Cortex-A78AE CPU	Arm Cortex-A78AE CPU
AGX Orin	AGX Orin	AGX Orin
32GB	64GB	64GB
No	4x 3G-SDI	4x 3G-SDI + 4x GMSL
2x M.2 NVMe+ 64GB eMMC 5.1 Flash	1x M.2 NVMe+ 64GB eMMC 5.1 Flash	1x M.2 NVMe+ 64GB eMMC 5.1 Flash
NA	NA	NA
NA	NA	NA
18V~36V	18V~36V	18V~36V
HDMI	HDMI	HDMI
250 x 325 x 84 mm	250 x 325 x 84 mm	250 x 325 x 84 mm
compliance	compliance	compliance
compliance	compliance	compliance
compliance	compliance	compliance



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# 7STARLAKE

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